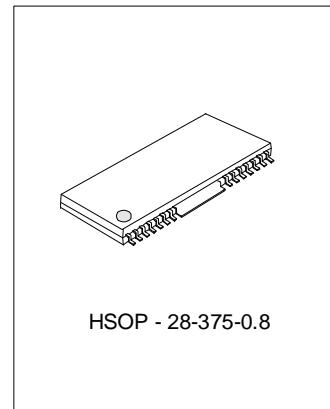


ACTUATOR DRIVER WITH CURRENT FEEDBACK FOR CD – ROM / DVD

DESCRIPTION

The SA5624 is a four-channel BTL driver IC. Two of them can drive DC motors and two can drive coils, such as focus and tracking actuators of a CD-ROM/DVD-ROM/DVD-PLAYER system, with current feedback.



FEATURES

- * 2 channels of DC motor BTL driver
- * 2 channels of BTL driver for coils with current feedback
- * Build-in thermal shutdown circuit
- * Operating voltage: 4.3V~13.2V

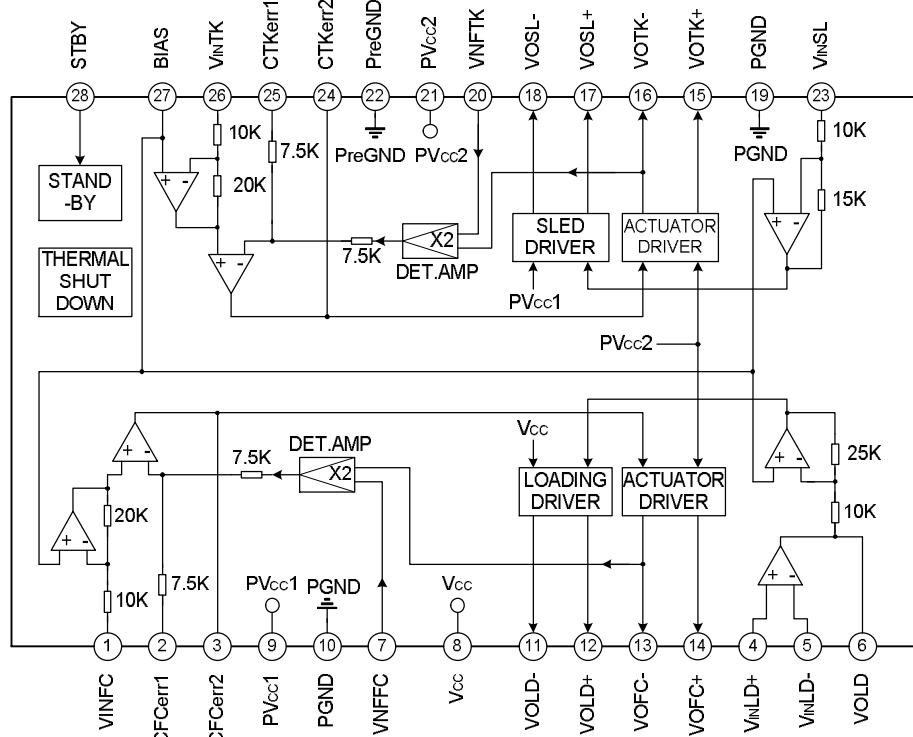
APPLICATIONS

- * CD-ROM, DVD

ORDERING INFORMATION

Part No.	Package
SA5624	HSOP-28-375-0.8

BLOCK DIAGRAM



ABSOLUTE MAXIMUM RATING (Tamb=25°C)

Characteristics	Symbol	Value	Unit
Power Supply Voltage	Vcc, PVCC1/2	13.5	V
Power Dissipation	PD	1.7*	W
Operating Temperature	Topr	-35~+85	°C
Storage Temperature	Tstg	-55~+150	°C

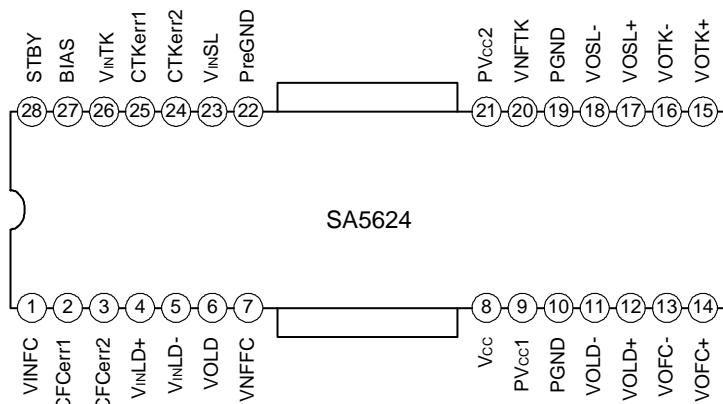
*When mounted on a 70mm X 70mm X 1.6mm glass epoxy board.

Reduced by 13.6mW for each increase in Tamb of 1°C over 25°C

ELECTRICAL CHARACTERISTICS

(Unless other specified, Tamb=25°C, Vcc=12V, PVCC1=PVCC2=5V, BIAS=2.5V, RL=8Ω, Rd=0.5Ω, C= 100pF)

Characteristics	Symbol	Test conditions	Min.	Typ.	Max.	Unit
Power Supply Voltage	Vcc		4.3	--	13.2	V
	PVCC1		4.3	--	VCC	
	PVCC2		4.3	--	VCC	
Quiescent Current	Icc		--	18	27	mA
Actuator Driver						
Output Offset Current	IOOF		-6	--	6	mA
Maximum Output Amplitude	VOM	VIN=BIAS ± 1.5V	3.6	4.0	--	V
Gain	GM	VIN=BIAS ± 0.2V	1.3	1.5	1.7	A/V
Loading Driver						
Maximum Output Voltage	VOHOP	No load	10.8	11.1	--	V
Output Voltage Offset	VOOFLD		-100	0	100	mV
Closed Loop Gain	GVLD	VIN=BIAS ± 0.2V	18.0	20.0	22.0	dB
Sled Driver						
Output Voltage Offset	VOOFLSL		-50	0	50	mV
Maximum Output Voltage	VOMSL	VIN=BIAS ± 1.5V PVCC1=5V	3.6	4.0	--	V
Closed Loop Gain	GVSL	VIN=BIAS ± 0.2V	13.5	15.5	17.5	dB
Gain error	Δ GVSL	VIN=BIAS ± 0.2V	0	1	2	dB
STBY Logic						
STBY On Voltage	VSTBY1	All Channels Off	0	--	0.5	V
STBY Off Voltage	VSTBY2	All Channels On	2.0	--	--	V

PIN CONFIGURATION

PIN DESCRIPTIONS

Pin No.	Pin Name	Description
1	VINFC	Input for focus driver
2	CFCerr1	Connection with capacitor for focus driver
3	CFCerr2	
4	VINLD+	Input (+) for the Loading driver
5	VINLD-	Input (-) for the Loading driver
6	VOLD	Output for the Loading driver
7	VNFFC	Feedback for focus driver
8	VCC	VCC
9	PVCC1	Power VCC for sled driver block
10	PGND	Power ground
11	VOLD-	Output (-) for loading driver
12	VOLD+	Output (+) for loading driver
13	VOFC-	Output (-) for focus driver
14	VOFC+	Output (+) for focus driver
15	VOTK+	Output (+) for tracking driver
16	VOTK-	Output (-) for tracking driver
17	VOSL+	Output (+) for sled driver
18	VOSL-	Output (-) for sled driver
19	PGND	Power ground
20	VNFTK	Feedback for tracking driver
21	PVCC2	Power VCC 2
22	PreGND	Pre ground
23	VINSL	Input for sled driver
24	CTKerr2	Connection with capacitor for tracking driver
25	CTKerr1	
26	VINTK	Input for tracking driver
27	BIAS	Bias input
28	STBY	Standby

Notes: The indicated polarities for the output pins are under the condition that all inputs are (+).

The power supply are PVCC2 for the focus, tracking drivers are PVCC2, PVCC1 for the sled driver, and Vcc for the pre-block and loading driver. Therefore, make sure $V_{cc} \geq V_{CC1, 2}$.

APPLICATION INFORMATION

(1) Thermal shutdown

If the chip temperature rises above 175°C , the thermal shutdown (TSD) circuit is activated and the output circuit enters the mute state, that is off state. The TSD circuit has a temperature hysteresis of 25°C .

(2) The driver buffer is switched off when the supply voltage falls below 3.5V (Typ.), and is switched back on when the voltage reaches 3.7V (Typ.) again.

(3) The stand by circuit logic

Stand-by input voltage	operation
Below 0.5V or open	The stand-by function is activated so the bias block and power block are disabled
Above 2.0V	Recover the normal operation

(4) Current feedback driver

Trans conductance (output current/input voltage) is shown as below

$$G_m = 1/(R_d + R_{wire}) \text{ (A/V)}$$

R_{wire} is the total wire resistance inside the package, $R_{wire} \approx 0.15\Omega \pm 0.05\Omega$ (typ)

ELECTRICAL CHARACTERISTICS CURVES

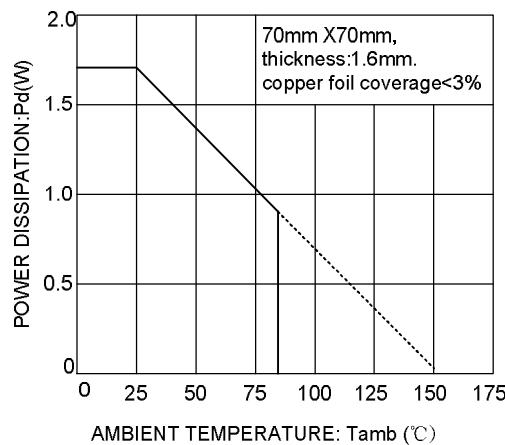
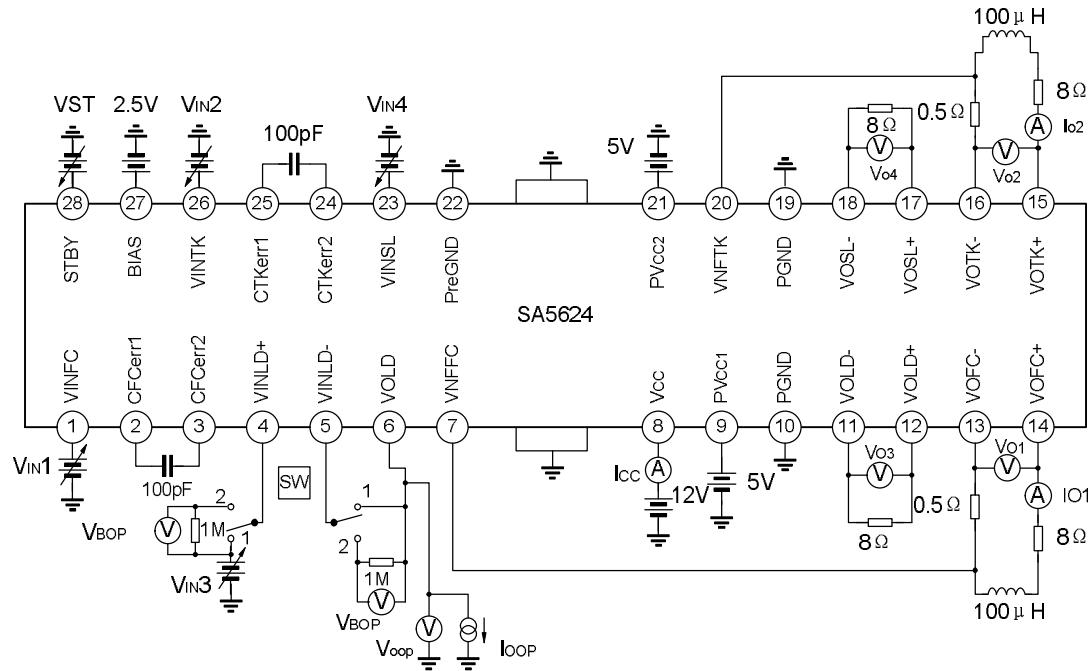
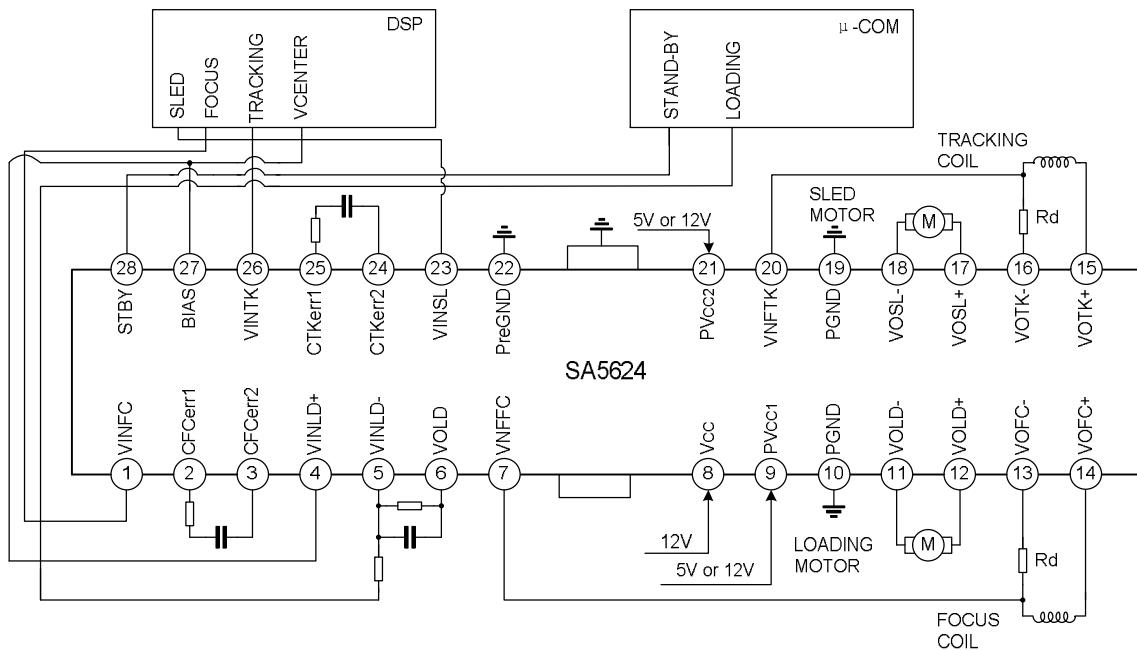
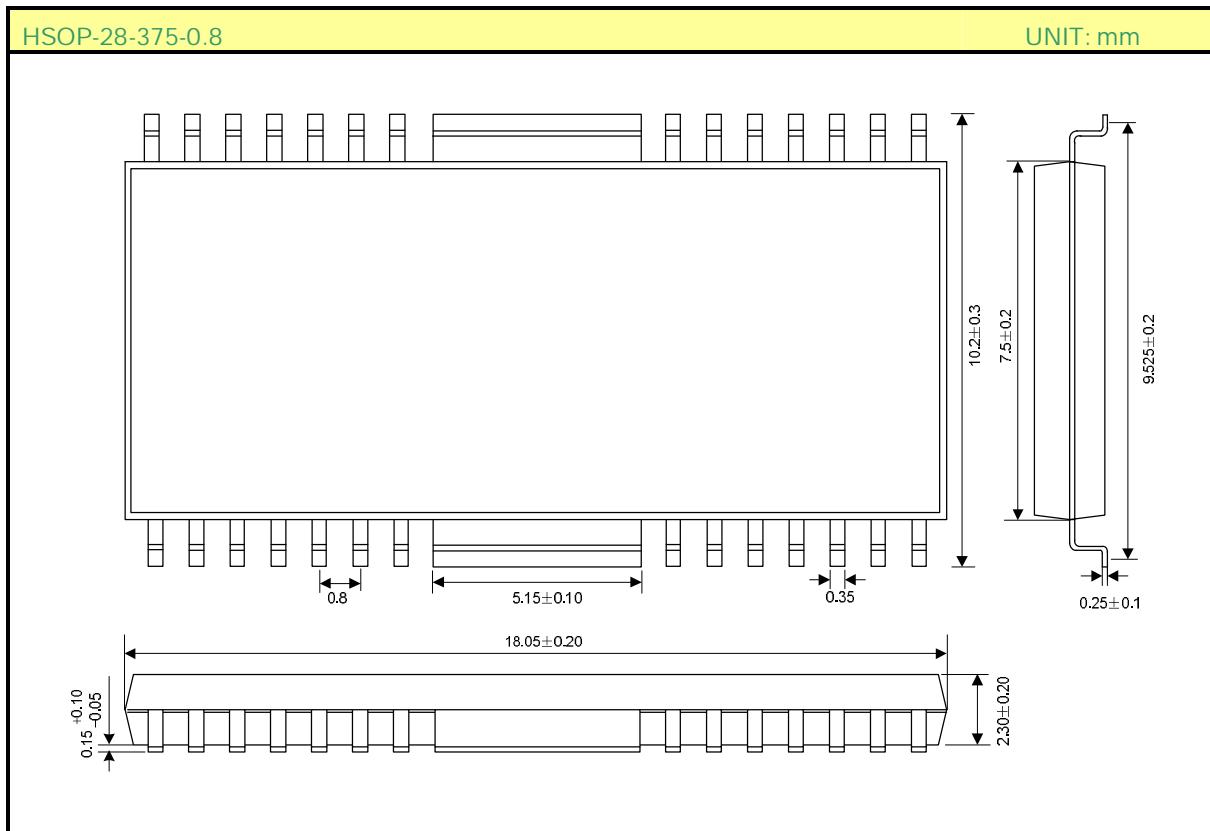


Fig 1. Thermal dissipation curve

TEST CIRCUIT

TYPICAL APPLICATION CIRCUIT


PACKAGE OUTLINE



ATTACHMENT

Revision History

Data	REV	Description	Page
2004.10.28	1.0	Original	
2005.06.21	1.1	Modify the "FUNCTION DESCRIPTION" Modify the "ELECTRICAL CHARACTERISTICS CURVE"	4 5